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> MOSFET (Si/SiC) (/cms/en/product/power/mosfet/)

> 650V-1700V Silicon Carbide MOSFET (/cms/en/product/power/mosfet/silicon-carbide/)

> Silicon Carbide MOSFET Modules (/cms/en/product/power/mosfet/silicon-carbide/modules/) > FS05MR12A6MA1B



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### Overview

This HybridPACK™ Drive is a very compact six-pack module (1200V/200A) optimized for hybrid and electric vehicles.

The power module implements the new CoolSiC™ Automotive MOSFET 1200V, optimized for electric drive train applications. The CoolSiC™ MOSFET was optimized for applications with switching frequencies in the range of 10kHz.

### Summary of Features

#### Electrical Features

- New semiconductor material - Silicon Carbide
- Blocking voltage 1200V
- Low RDSon
- Low Switching Losses
- Low Qg and Crss
- Tvj op= 150°C

#### Mechanical Features

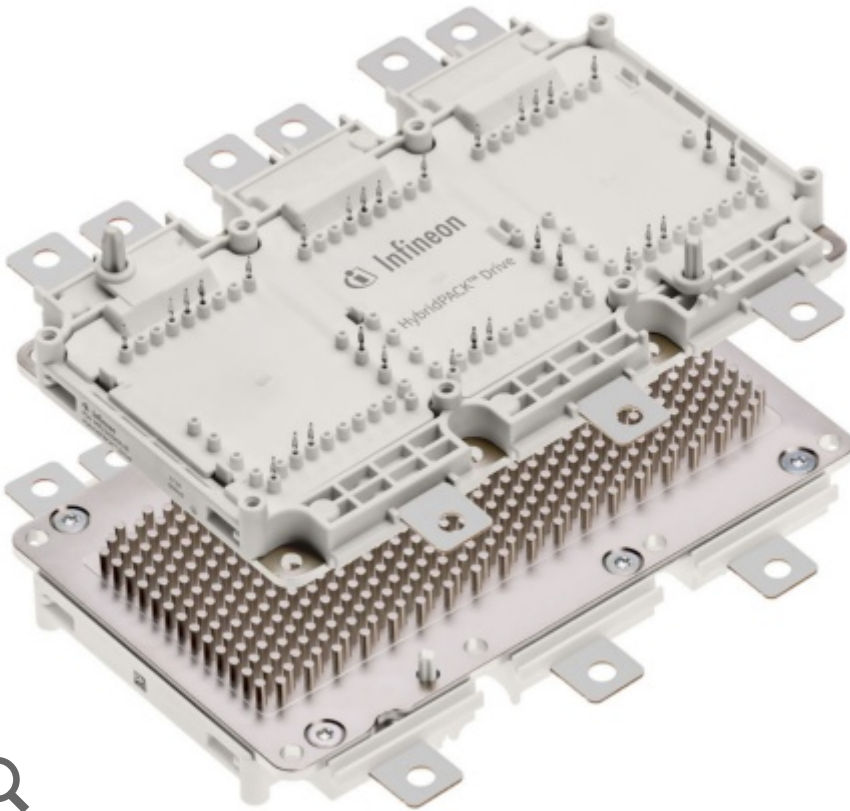
- 4.2kV DC 1sec Insulation
- High Creepage and Clearance Distances
- Compact design
- High Power Density
- Direct Cooled PinFin Base Plate
- High Performance Si3N4 Ceramic
- Guiding elements for PCB and cooler assembly
- Integrated NTC temperature sensor
- PressFIT Contact Technology
- RoHS compliant
- UL 94 V0 module frame

### **Benefits**

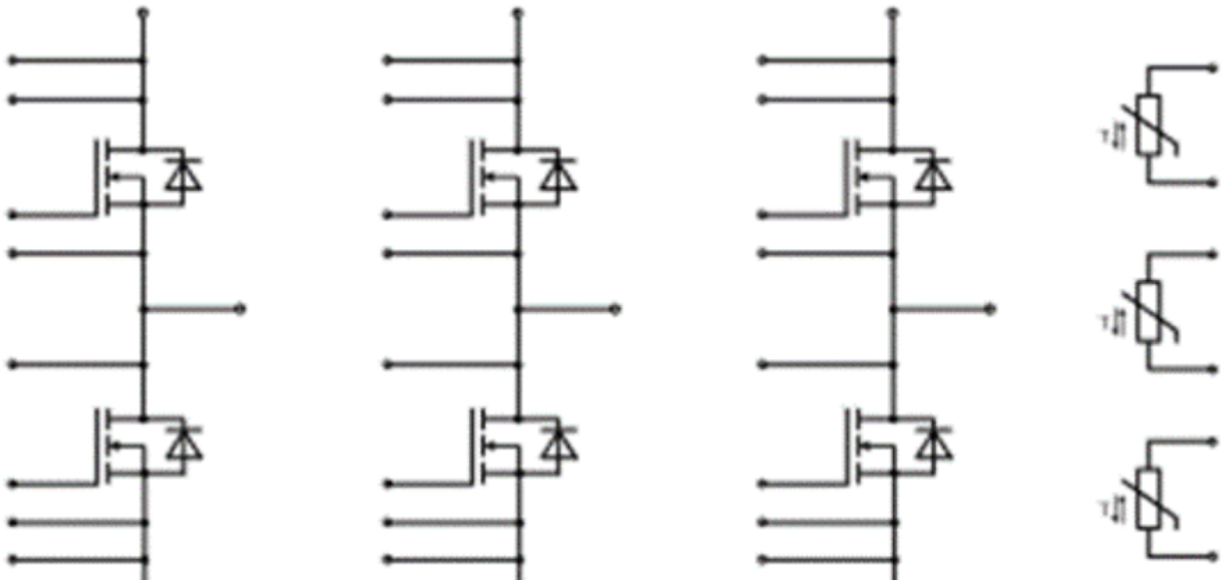
- Compact Design
- Direct Cooled Base Plate
- Guiding elements for PCB and cooler assembly
- Integrated NTC temperature sensor
- PressFIT Contact Technology
- RoHS compliant
- Superior reliability

### **Potential Applications**

- Main inverter
- Automotive Applications
- Hybrid Electrical Vehicles (H)EV
- Motor Drives
- Commercial Agriculture Vehicles



Diagrams





## Parametrics

<b>Parametrics</b>	<b>FS05MR12A6MA1B</b>
Configuration	Sixpack
Dimensions (length)	154.5 mm
Dimensions (width)	100.5 mm
Features	PinFin Base Plate
Housing	HybridPACK™ Drive
$I_D$	200.0 A
$R_{DS(on)}$ (@ $T_j = 25^\circ\text{C}$ )	5.5 mΩ
$V_{DS}$	1200.0 V

## Documents

## + Editorials



Effects of a SiC TMOSFET tractions inverters on the electric vehicle drivetrain (/dgd/Infineon-Effects\_of\_a\_SiC\_TMOSFET\_tractions\_inverters\_on\_the\_electric\_vehicle\_drivetrain-Editorials-v01\_00-EN.pdf?fileId=5546d4627600a6bc017601596e5162b8)

> EN (/dgd/Infineon-Effects\_of\_a\_SiC\_TMOSFET\_tractions\_inverters\_on\_the\_electric\_vehicle\_drivetrain-Editorials-v01\_00-EN.pdf?fileId=5546d4627600a6bc017601596e5162b8)

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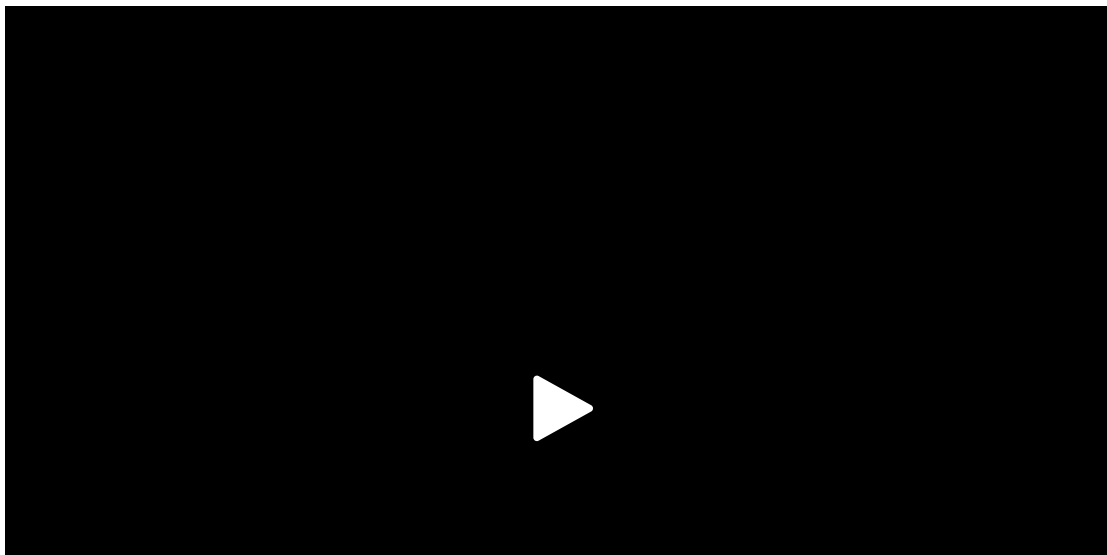
01\_00 | 2020-11-25 | pdf | 1.2 MB

## Order

<b>Sales Product Name</b>	<b>FS05MR12A6MA1B</b>
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<b>OPN Sales Product Name</b>	FS05MR12A6MA1BBPSA1 <b>FS05MR12A6MA1B</b>
<b>Product Status</b>	active and preferred
<b>Package name</b>	AG-HYBRIDD-2
<b>Order online</b>	
<b>Completely lead free</b>	no
<b>Halogen free</b>	no
<b>RoHS compliant</b>	yes
<b>Packing Size</b>	6
<b>Packing Type</b>	TRAY
<b>Moisture Level</b>	NA
<b>Moisture Packing</b>	NON DRY

## Videos



## CoolSiC™ for automotive applications

With an outstanding quality of robust, large and reliable semiconductor portfolio of automotive CoolSiC™ devices, Infineon is paving the way for carbon-efficient e-mobility.

### Support

Search the FAQs! Enter your search terms...



Top 6 FAQs. Use the search bar above to show more!

#### Technical Support

In order to enable us to process your inquiry as efficiently as possible and ensure your case is duly reported, we kindly ask you to submit your request via the following support form:

**<https://www.infineon.com/tac> (<https://www.infineon.com/tac>)**

...

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#### Partner Finder for support, software, hardware, dev tools, services

Infineon's partners offer products and services that complement our semiconductor device solutions to accelerate your development efforts and time to market.

**<https://www.infineon.com/partnerfinder> (<https://www.infineon.com/partnerfinder>)**

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#### Package information

The package information is available on our homepage at **<https://www.infineon.com/packages> (<https://www.infineon.com/packages>)**. Please note, that they are divided into the subcategories "Leaded and through-hole", "Surface Mounted Devices" and "Special Packages". You will find all relevant package information at the option that applies.

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## Notes on processing

Information regarding reflow profile, soldering temperature, soldering profile and further processing notes for most of the discrete products are mentioned in the Application Note.

Please visit <https://www.infineon.com/packages> (<https://www.infineon.com/packages>) and refer to the document "General Recommendations for Assembly of Infineon Packages" under Downloads....

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## Design-in support

We offer design-in support for your application.

You can find the Infineon Solution Finder at <https://www.infineon.com/solutionFinder> (<https://www.infineon.com/solutionFinder>)

Here you select the relevant parameters of your application and narrow down your choice according to your requirements.

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## Simulation Parameters/SPICE models

Please visit our Simulation Model Finder on the internet at

<https://www.infineon.com/simulation> (<https://www.infineon.com/simulation>)

Please select "Simulation Models (SPICE, S-parameters, SABER)"

If you cannot find your requested model there, please submit your request via the "click to request..."

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